

### WARM WELCOME!



Ms. Rozalia Beica

TRENDS,

MANUFACTURING

READINESS, SUPPLY

CHAIN FOR FAN-OUT &

FAN-IN WLP, TSV, LED

PACKAGING.



Dr. Leo Lorenz

POWER DEVICES AND

PACKAGING

TECHNOLOGIES

TRENDS AND

CHALLENGES ON

FUTURE POWER

ELECTRONIC SYSTEM

DEVELOPMENT



EASTERN & ORIENTAL HOTEL, PENANG, 23<sup>RD</sup> SEPTEMBER, 2013 PALM GARDEN HOTEL IOI RESORT, PUTRAJAYA, 24<sup>TH</sup> SEPTEMBER, 2013

7:45 AM REGISTRATION/

**WELCOME DRINKS** 

8:30 AM PART 1 by Ms. Rozalia Beica

Trends, manufacturing

readiness, supply chain for fan-

out & fan-in WLP, TSV, LED

packaging

12:00 PM BUFFET LUNCH

1:30 PM PART 2 by Dr. Leo Lorenz

Power devices and packaging

technologies trends and

challenges on future power

electronic system development

5:00 PM END



## EASTERN & ORIENTAL HOTEL, PENANG, 23<sup>RD</sup> SEPTEMBER, 2013

10, Lebuh Farquhar, 10200 Georgetown, Pulau Pinang, Malaysia

Macalister Ballroom
Level 5 (Victory Annexe Wing)

Multi-storey car park is available at Rm6 (7AM – 10PM)



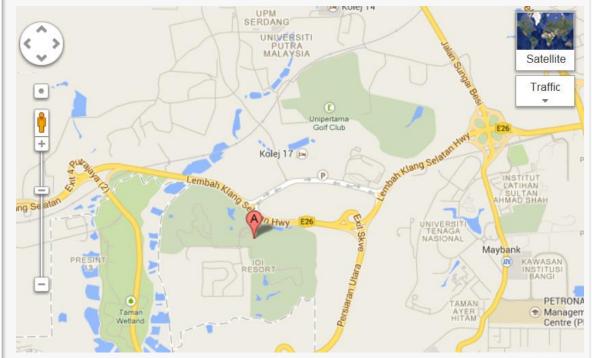


## PALM GARDEN HOTEL IOI RESORT, PUTRAJAYA, 24<sup>TH</sup> SEPTEMBER, 2013

62502 Putrajaya, Malaysia

## Putra 1 Ground Floor

Open air car park is FOC (7AM - 10PM)





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